

Output Rail-to-Rail Micropower Operational Amplifiers

- Rail-to-rail output voltage swing
- Micropower consumption (1.2μA)
- Single supply operation (2.5V to 10V)
- CMOS inputs
- Ultra low input bias current (1pA)
- ESD protection (2kV)
- Latch-up immunity (class A)
- Available in SOT23-5 micropackage

Description

The TS94x (single, dual & quad) series are operational amplifiers characterized for 2.5V to 10V operation over -40°C to +85°C temperature range.

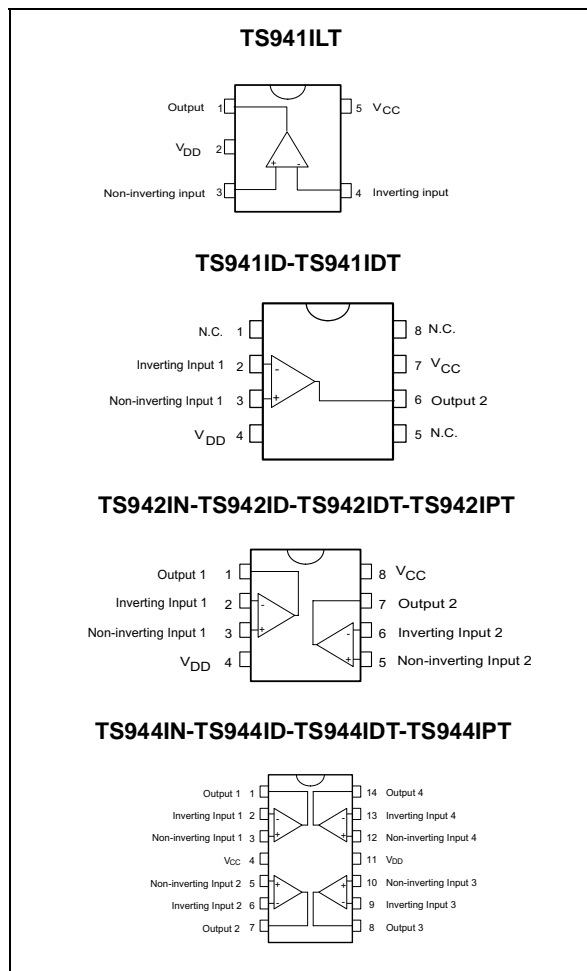
They exhibit excellent consumption - 1.2μA, while featuring 10kHz gain bandwidth product, 1.5mA output capability and output rail-to-rail operation - 2.85V typ @ 3V with $R_L=10k\Omega$.

The TS94x op-amps are ideal for battery-powered systems, where very low supply current and output rail-to-rail are required. Their very low - 1pA typ input bias current and constant supply current over supply voltage enhance TS94x's performance near the end of the life battery charge.

Applications

- Battery-powered systems (alarm)
- Portable communication systems (paggers)
- Smoke/gas/fire detectors
- Instrumentation & sensing
- PH meter

Pin Connections (top view)



Order Codes

Part Number	Temperature Range	Package	Packaging	Marking
TS941ID/IDT/AID/AIDT/BID/BIDT	-40°C, +85°C	SO	Tube or Tape & Reel	
TS941ILT/AILT/BILT		SOT23-5L	Tape & Reel	K201 K202 K203
TS942IN/AIN/BIN		DIP	Tube	
TS942ID/IDT/AID/AIDT/BID/BIDT		SO	Tube or Tape & Reel	
TS942IPT/AIPT/BIPT		TSSOP (Thin Shrink Outline Package)	Tape & Reel	
TS944IN/AIN/BIN		DIP	Tube	
TS944ID/IDT/AID/AIDT/BIDT/BIDT		SO	Tube or Tape & Reel	
TS944IPT/AIPT/BIPT		TSSOP (Thin Shrink Outline Package)	Tape & Reel	

1 Absolute Maximum Ratings

Table 1: Key parameters and their absolute maximum ratings

Symbol	Parameter	Value	Unit
VCC	Supply voltage ¹	12	V
V _{id}	Differential Input Voltage ²	±12	V
V _{in}	Input Voltage Range ³	V _{dd} -0.3 to V _{cc} +0.3	V
T _{std}	Storage Temperature Range	-65 to +150	°C
T _j	Maximum Junction Temperature	150	°C
R _{thja}	Thermal Resistance Junction to Ambient ⁴ SOT23-5 DIP8 DIP14 SO8 SO14 TSSOP8 TSSOP14	250 85 66 125 103 120 100	°C/W
ESD	HBM: Human Body Model ⁵	2	kV
	MM: Machine Model ⁶ (TS941, TS942)	200	V
	CDM: Charged Device Model TS941	1.5	kV
	TS942	1	kV
	Latch-up Immunity	200	mA
	Lead Temperature (soldering, 10sec)	250	°C

1) All voltages values, except differential voltage are with respect to network terminal.

2) Differential voltages are non-inverting input terminal with respect to the inverting input terminal.

3) The magnitude of input and output voltages must never exceed V_{CC} +0.3V.

4) Short-circuits can cause excessive heating and destructive dissipation.

5) Human body model, 100pF discharged through a 1.5kΩ resistor into pin of device.

6) Machine model ESD, a 200pF cap is charged to the specified voltage, then discharged directly into the IC with no external series resistor (internal resistor < 5Ω), into pin to pin of device.

Table 2: Operating Conditions

Symbol	Parameter	Value	Unit
VCC	Supply Voltage	2.5 to 10	V
V _{icm}	Common Mode Input Voltage Range	V _{DD} -0.2 to V _{CC} -1.3	V
T _{oper}	Operating Free Air Temperature Range	-40 to + 85	°C

2 Electrical Characteristics

Table 3: $V_{CC} = +2.5V$, $V_{DD} = 0V$, R_L connected to $V_{CC/2}$, $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input Offset Voltage TS941/2/4 TS941/2/4A TS941/2/4B			10 5 2	mV
ΔV_{io}	Input Offset Voltage Drift		7		$\mu V/^\circ C$
I_{io}	Input Offset Current ¹⁾		1	100	pA
I_{ib}	Input Bias Current ¹⁾		1	150	pA
CMR	Common Mode Rejection Ratio	60	85		dB
SVR	Supply Voltage Rejection Ratio	50	78		dB
A_{vd}	Large Signal Voltage Gain $V_O = 2V_{pp}$ $R_L = 1M\Omega$		100		dB
V_{OH}	High Level Output Voltage $V_{ID} = 100mV$ $R_L = 1M\Omega$ $R_L = 10k\Omega$	2.45 2.3	2.49 2.4		V
V_{OL}	Low Level Output Voltage $V_{ID} = -100mV$ $R_L = 1M\Omega$ $R_L = 10k\Omega$		1 100	5 200	mV
I_o	Output Source Current $V_{ID} = 100mV$, $V_O = V_{DD}$ Output Sink Current $V_{ID} = -100mV$, $V_O = V_{CC}$	350 280	650 500		μA
I_{CC}	Supply Current (per amplifier) $A_{VCL} = 1$, no load		1.2	1.8	μA
GBP	Gain Bandwidth Product $R_L = 1M\Omega$, $C_L = 50pF$		10		kHz
SR	Slew Rate $R_L = 1M\Omega$, $C_L = 50pF$	3	4.5		V/ms
ϕ_m	Phase Margin $C_L = 50pF$		65		Degrees

1) Maximum values including unavoidable inaccuracies of the industrial test.

Table 4: $V_{CC} = +3V$, $V_{DD} = 0V$, R_L connected to $V_{CC/2}$, $T_{amb} = 25^{\circ}C$ (unless otherwise specified) ²⁾

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input Offset Voltage TS941/2/4 TS941/2/4A TS941/2/4B			10 5 2	mV
ΔV_{io}	Input Offset Voltage Drift		7		$\mu V/^{\circ}C$
I_{io}	Input Offset Current ¹⁾		1	100	pA
I_{ib}	Input Bias Current ¹⁾		1	150	pA
CMR	Common Mode Rejection Ratio	60	85		dB
SVR	Supply Voltage Rejection Ratio	50	85		dB
A_{vd}	Large Signal Voltage Gain $V_O = 2V_{pp}$, $R_L = 1M\Omega$		100		dB
V_{OH}	High Level Output Voltage $V_{ID} = 100mV$ $R_L = 1M\Omega$ $R_L = 10k\Omega$	2.9 2.8	2.99 2.85		V
V_{OL}	Low Level Output Voltage $V_{ID} = -100mV$ $R_L = 1M\Omega$ $R_L = 10k\Omega$		1 100	5 200	mV
I_o	Output Source Current $V_{ID} = 100mV$, $V_O = V_{DD}$	680	1500		μA
	Output Sink Current $V_{ID} = -100mV$, $V_O = V_{CC}$	650	1300		
I_{CC}	Supply Current (per amplifier) $A_{VCL} = 1$, no load		1.2	1.8	μA
GBP	Gain Bandwidth Product $R_L = 1M\Omega$, $C_L = 50pF$		10		kHz
SR	Slew Rate $R_L = 1M\Omega$, $C_L = 50pF$	3	4.5		V/ms
ϕ_m	Phase Margin $C_L = 50pF$		65		Degrees

1) Maximum values including unavoidable inaccuracies of the industrial test.

2. All electrical values are guaranteed with correlation measurements at 2.5V and 5V

Table 5: $V_{CC} = +5V$, $V_{DD} = 0V$, R_L connected to $V_{CC}/2$, $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input Offset Voltage TS941/2/4 TS941/2/4A TS941/2/4B			10 5 2	mV
ΔV_{io}	Input Offset Voltage Drift		7		$\mu V/^\circ C$
I_{io}	Input Offset Current ¹⁾		1	100	pA
I_{ib}	Input Bias Current ¹⁾		1	150	pA
CMR	Common Mode Rejection Ratio	60	85		dB
SVR	Supply Voltage Rejection Ratio	50	85		dB
A_{vd}	Large Signal Voltage Gain $V_O = 2V_{pp}$ $R_L = 1M\Omega$		100		dB
V_{OH}	High Level Output Voltage $V_{ID} = 100mV$ $R_L = 1M\Omega$ $R_L = 10k\Omega$	4.9 4.8	4.99 4.85		V
V_{OL}	Low Level Output Voltage $V_{ID} = -100mV$ $R_L = 1M\Omega$ $R_L = 10k\Omega$		1 100	5 150	mV
I_o	Output Source Current $V_{ID} = 100mV$, $V_O = V_{DD}$	3	4.5		mA
	Output Sink Current $V_{ID} = -100mV$, $V_O = V_{CC}$	3.7	5		
I_{CC}	Supply Current (per amplifier) $A_{VCL} = 1$, no load		1.2	1.85	μA
GBP	Gain Bandwidth Product $R_L = 1M\Omega$, $C_L = 50pF$		10		kHz
SR	Slew Rate $R_L = 1M\Omega$, $C_L = 50pF$	3	4.5		V/ms
ϕ_m	Phase Margin $C_L = 50pF$		65		Degrees

1) Maximum values including unavoidable inaccuracies of the industrial test.

Figure 1:

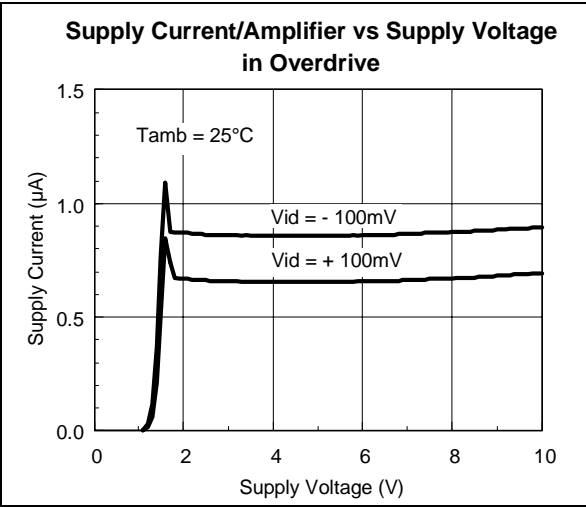


Figure 3:

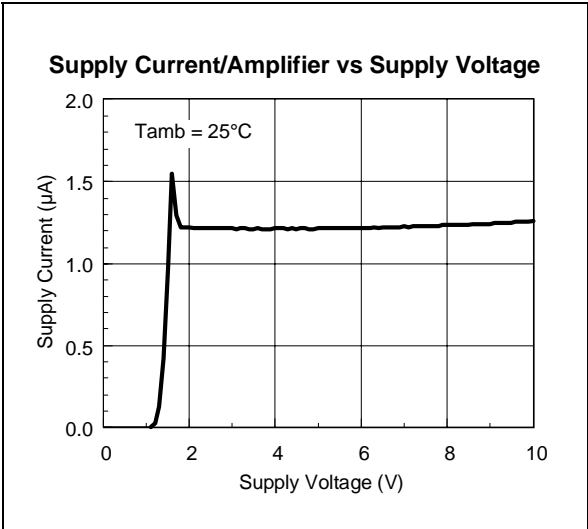


Figure 2:

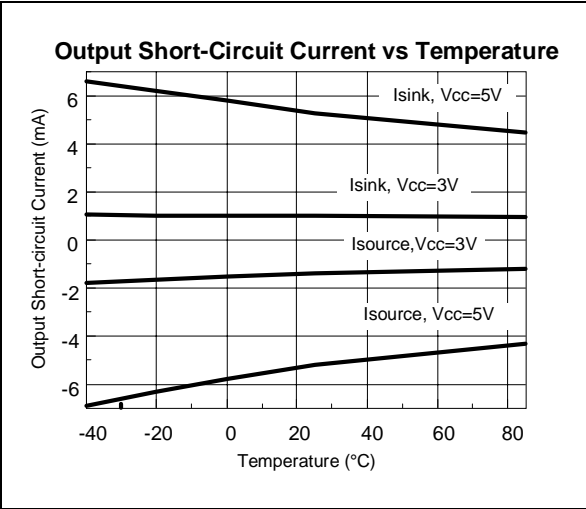


Figure 4:

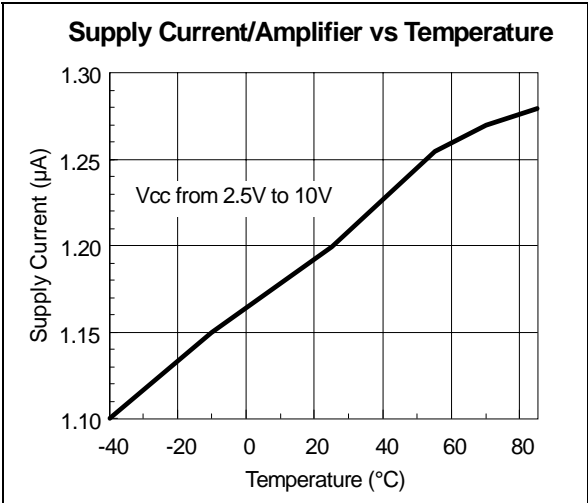


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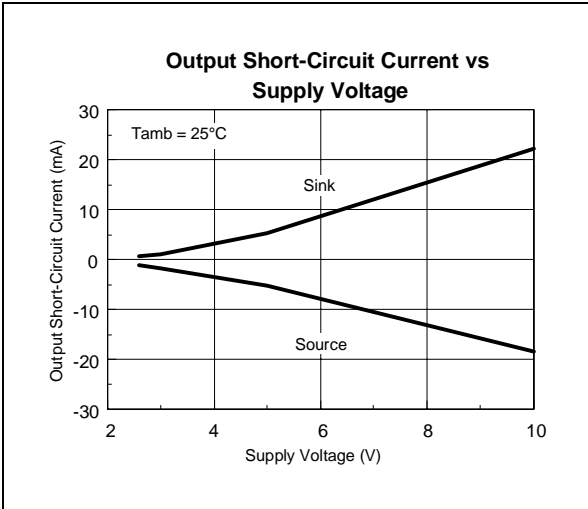


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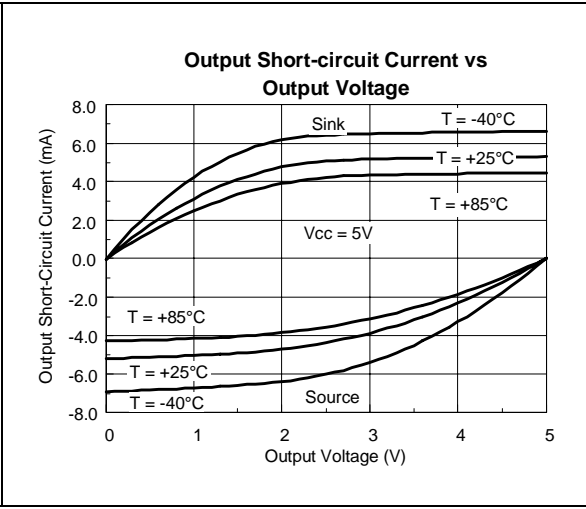


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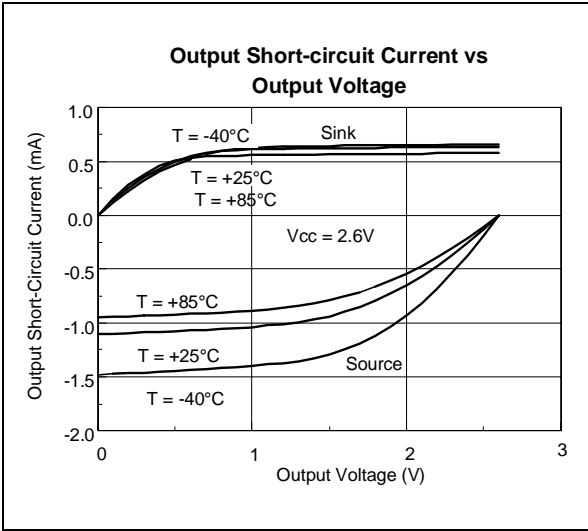


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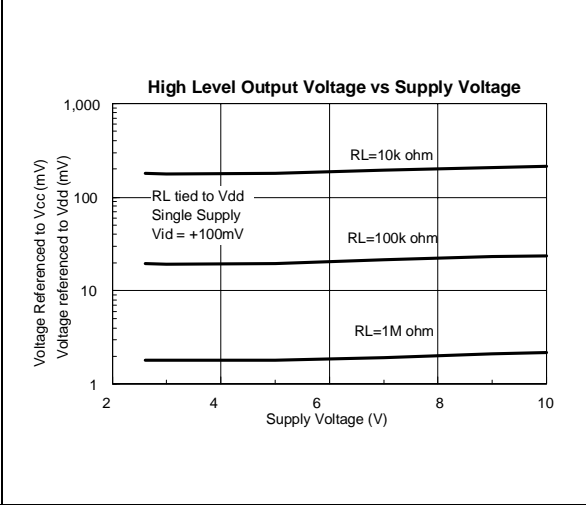


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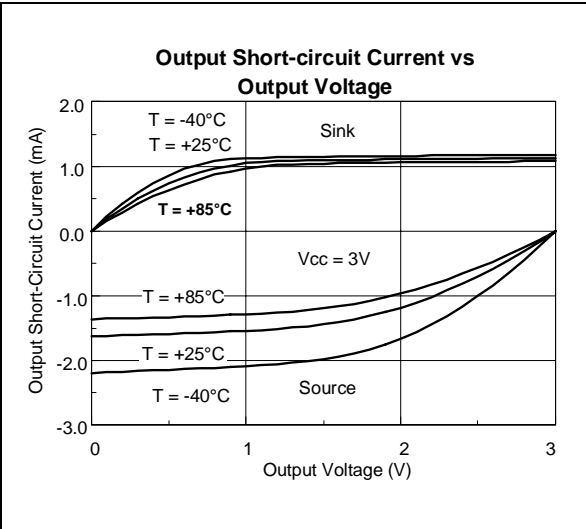


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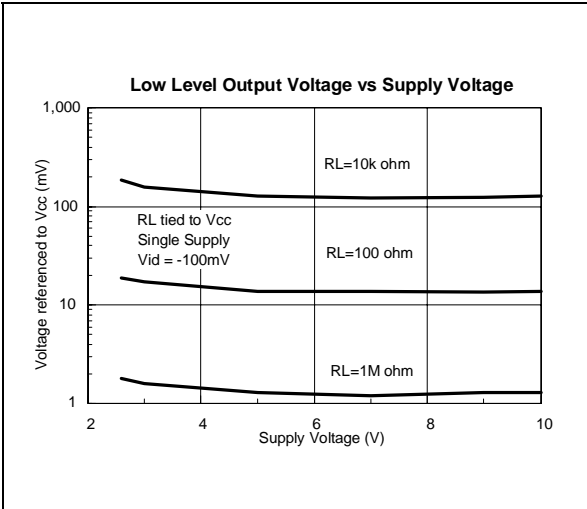


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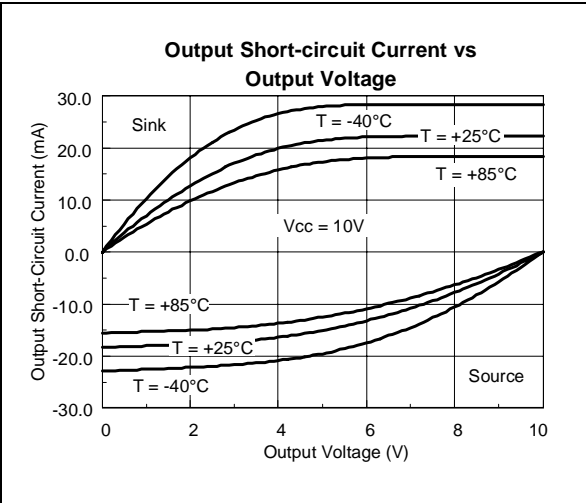


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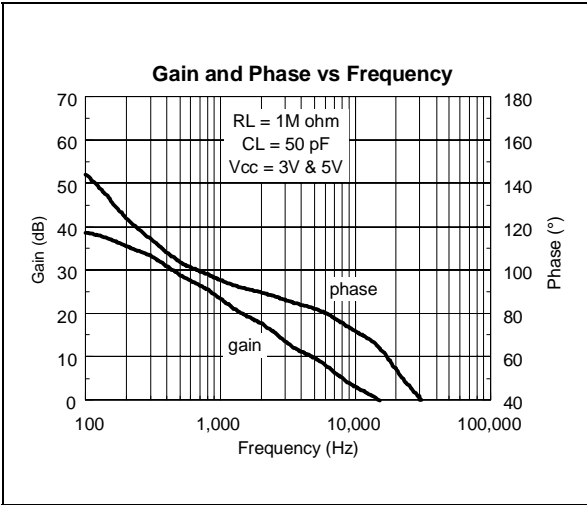


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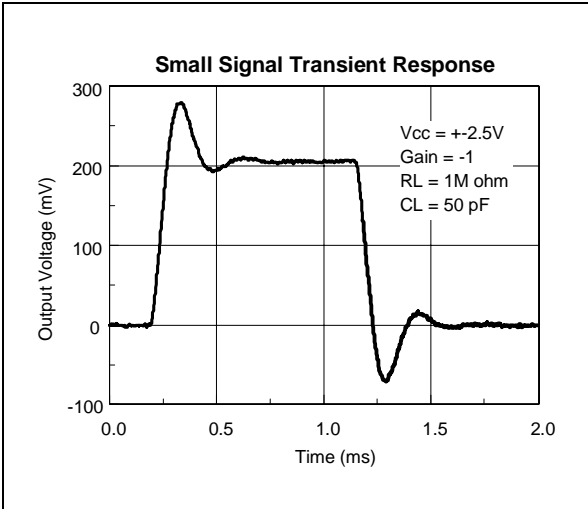


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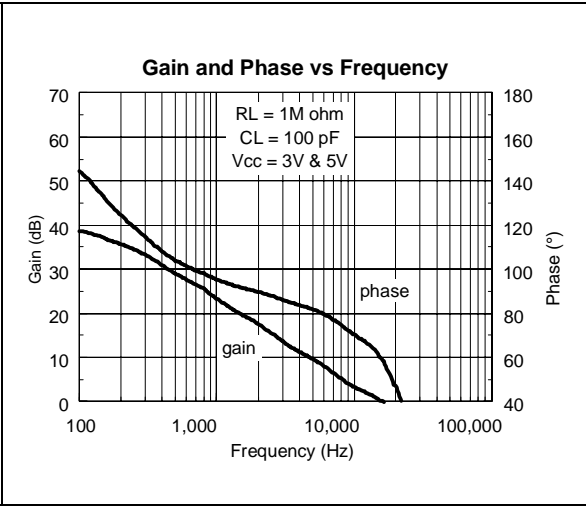


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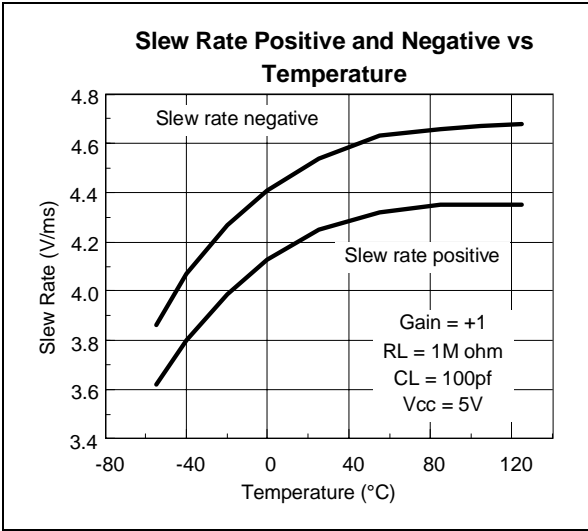
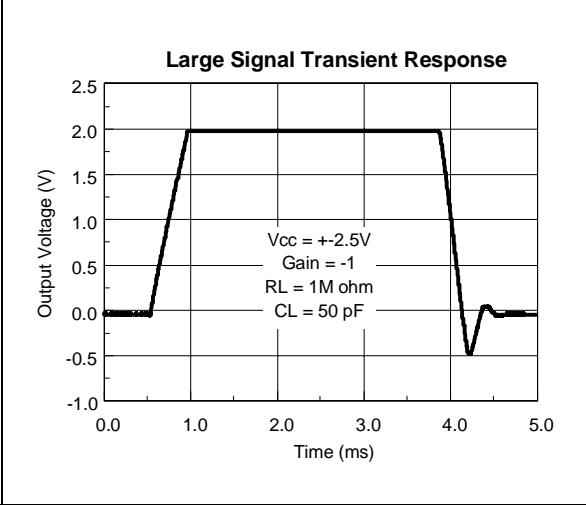
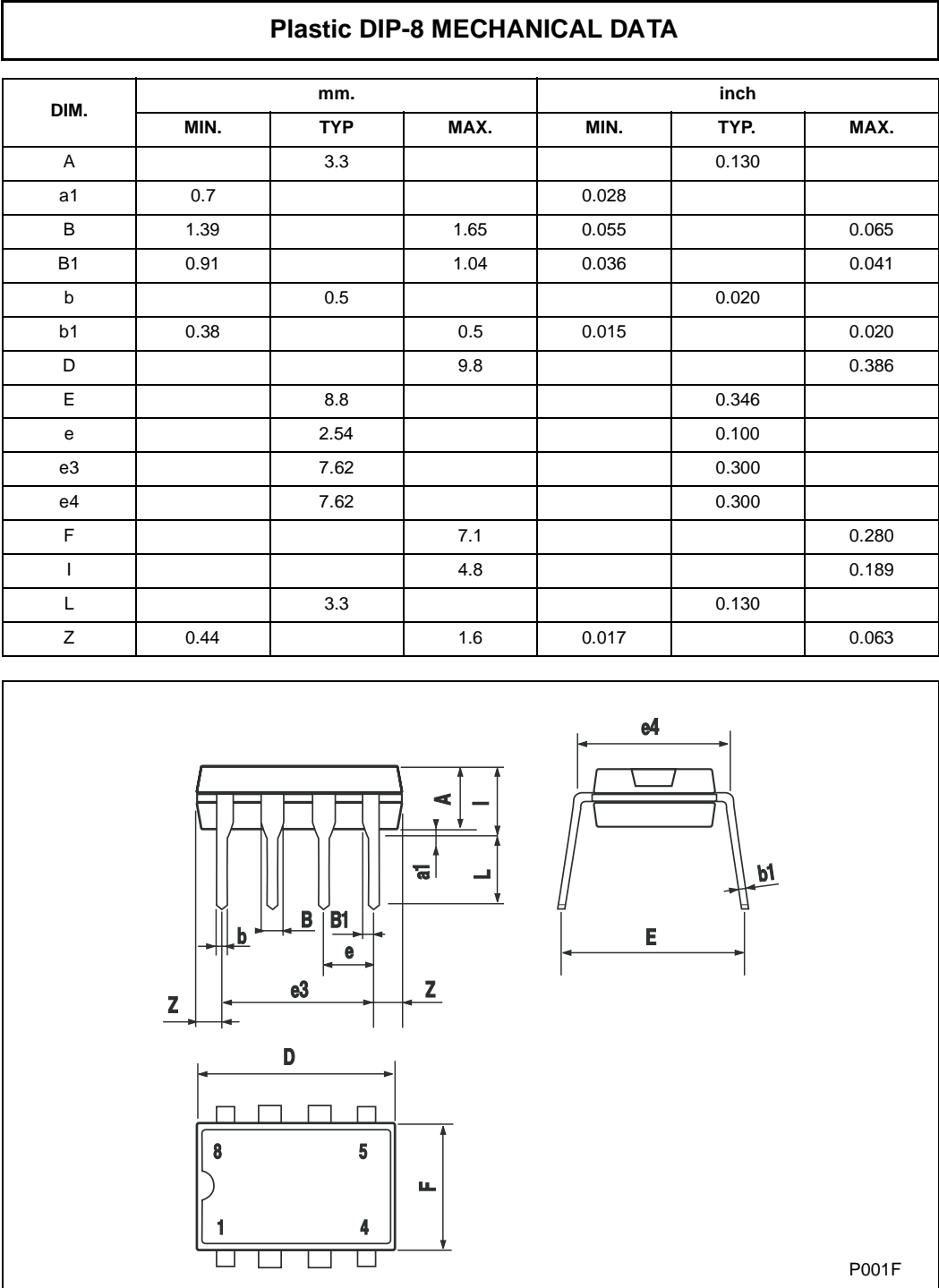


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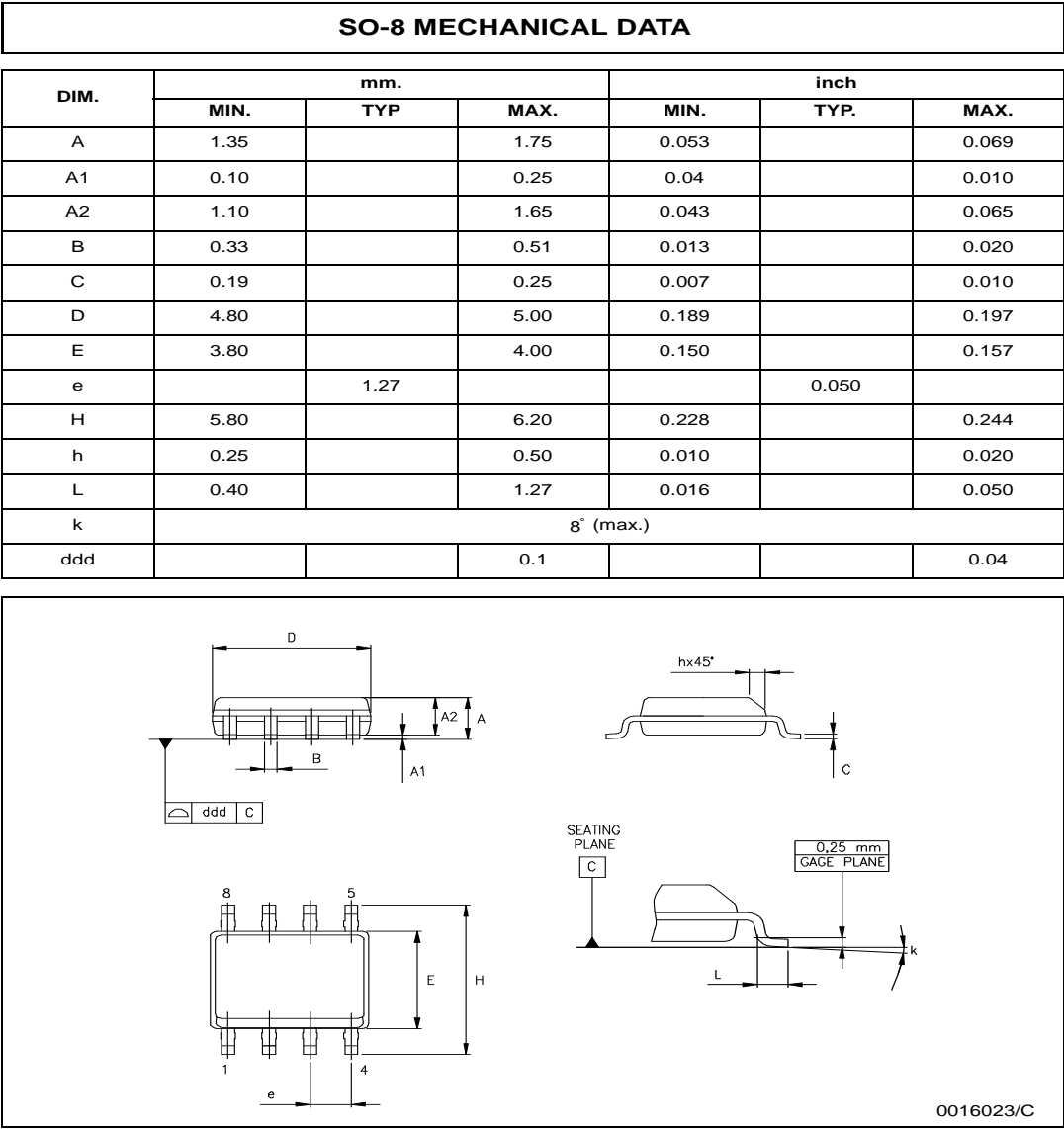


3 Package Mechanical Data

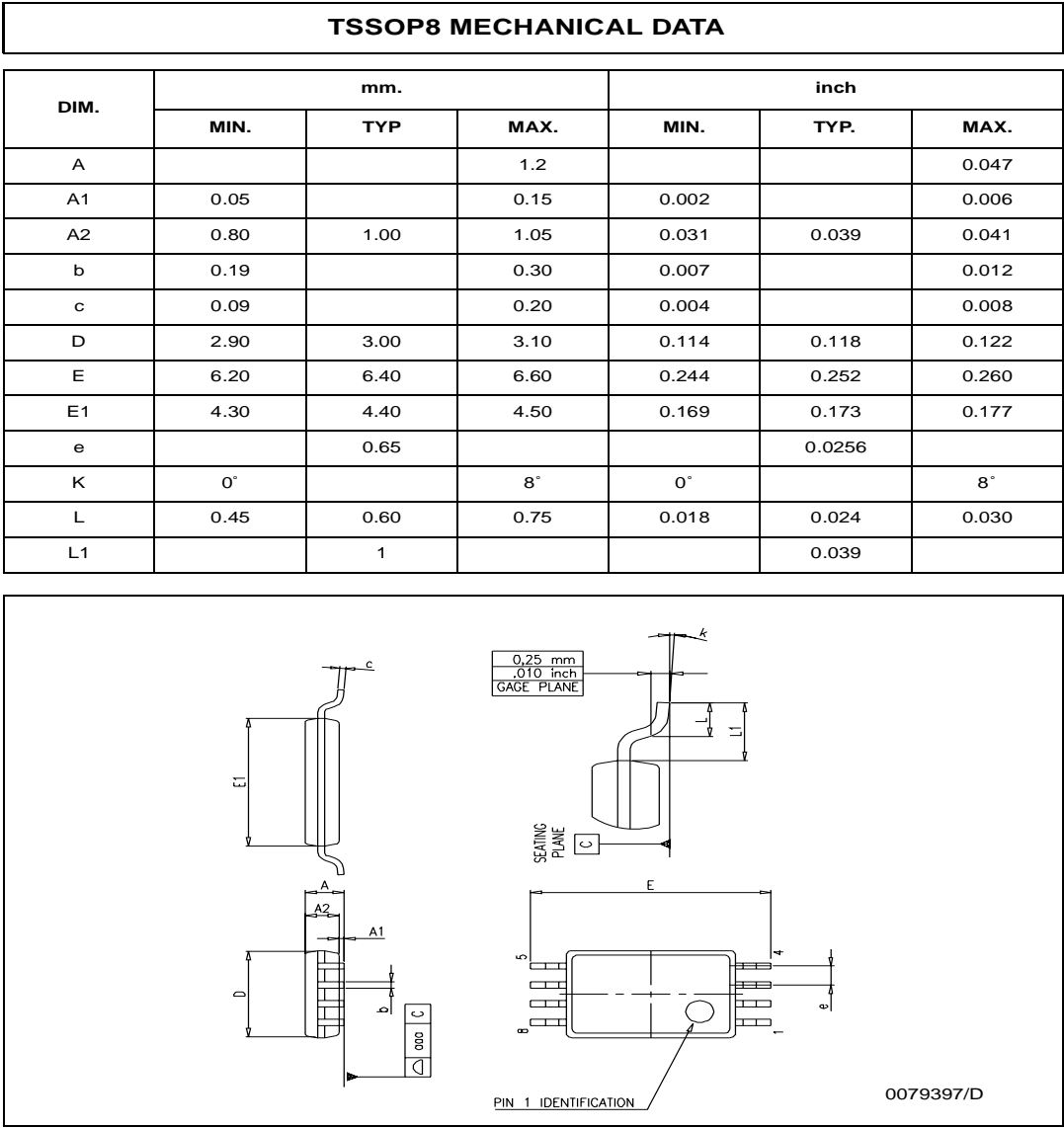
3.1 DIP8 package



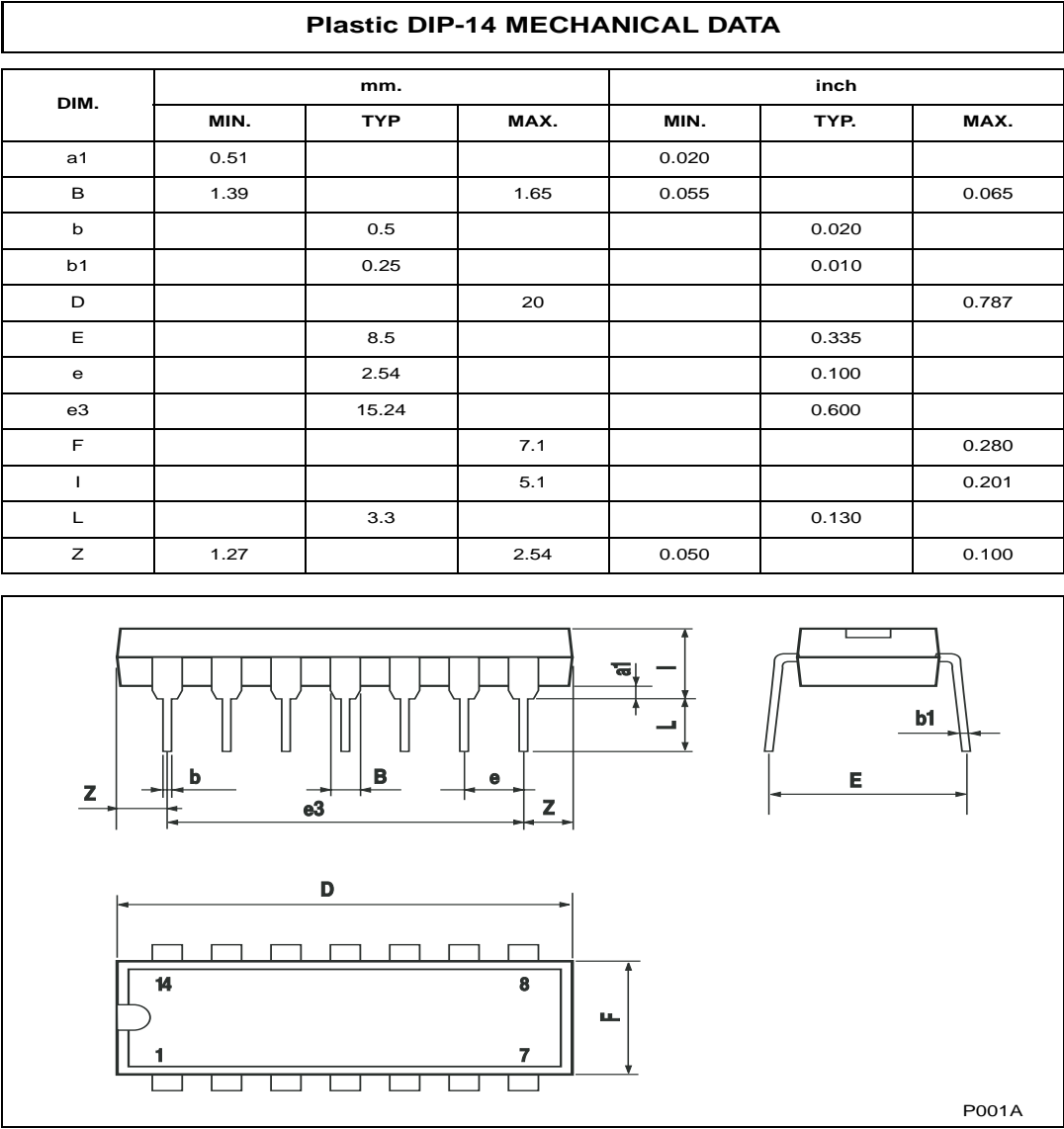
3.2 SO8 package



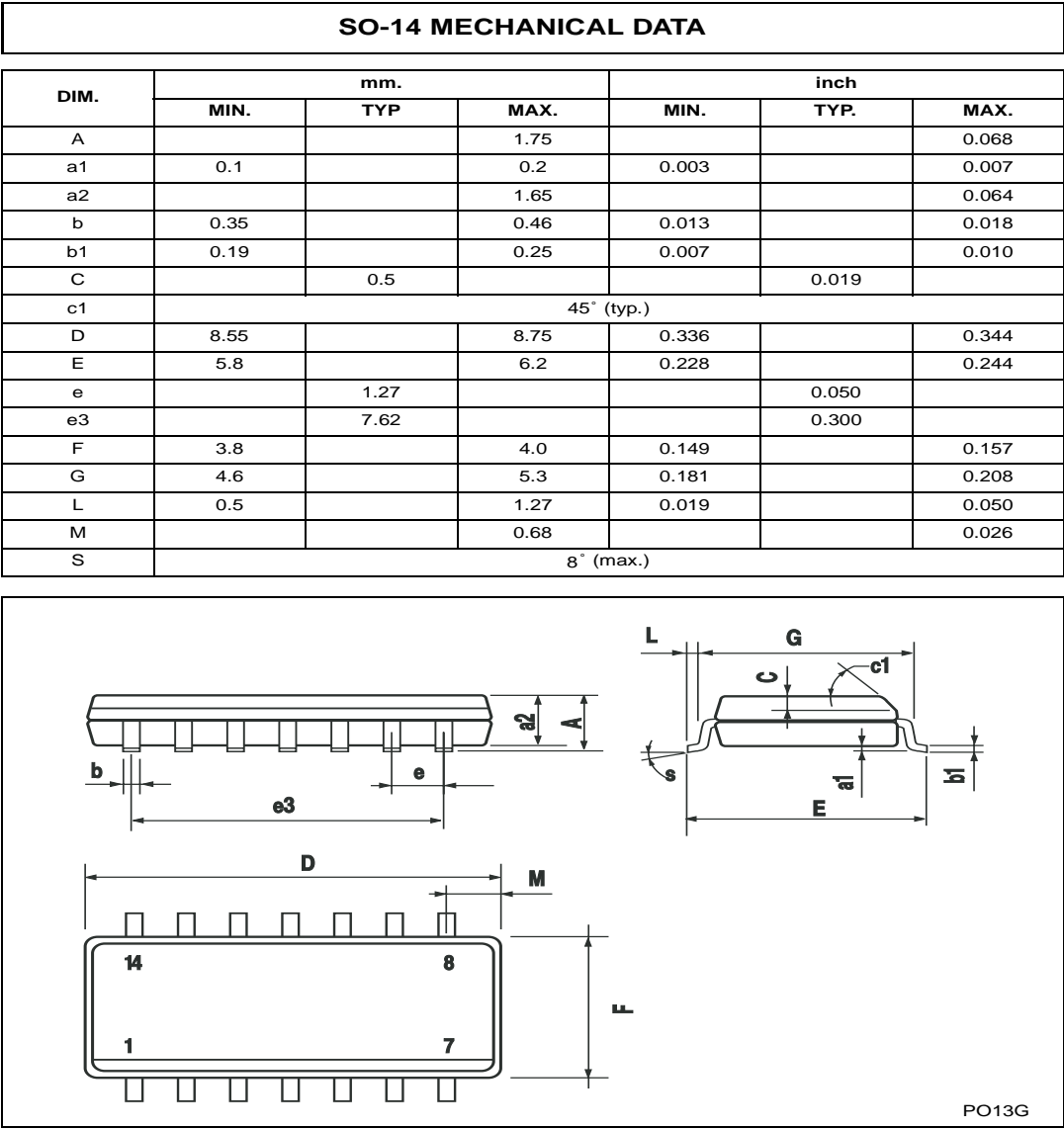
3.3 TSSOP8 package



3.4 DIP14 package



3.5 SO14 package



3.6 TSSOP14 package

TSSOP14 MECHANICAL DATA						
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030

The diagram illustrates the mechanical specifications of the TSSOP14 package. It includes three views: a top view, a side view, and a pin 1 identification view. The top view shows the package's footprint with dimensions D (width), E (length), and E1 (length of the central body). The side view shows the package's profile with dimensions A (total height), A1 (lead height), A2 (lead thickness), b (lead width), c (lead thickness), and K (lead angle). The pin 1 identification view shows the package with a circle indicating the location of pin 1. The text 'PIN 1 IDENTIFICATION' is shown with an arrow pointing to the circle. The number '1' is shown at the bottom left of the package.

0080337D

3.7 SOT23-5 package

SOT23-5L MECHANICAL DATA						
DIM.	mm.			mils		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	0.90		1.45	35.4		57.1
A1	0.00		0.15	0.0		5.9
A2	0.90		1.30	35.4		51.2
b	0.35		0.50	13.7		19.7
C	0.09		0.20	3.5		7.8
D	2.80		3.00	110.2		118.1
E	2.60		3.00	102.3		118.1
E1	1.50		1.75	59.0		68.8
e		0.95			37.4	
e1		1.9			74.8	
L	0.35		0.55	13.7		21.6

The diagram illustrates the mechanical specifications of the SOT23-5L package. The left side shows a side profile with dimensions A (total width), A1 (lead thickness), A2 (lead width), C (lead thickness at base), and L (lead length). The right side shows a top-down view with dimensions D (package width), E (package height), E1 (package height to lead top), e (lead pitch), e1 (lead pitch to center), and b (lead width).

4 Summary of Changes OU

Date	Revision	Description of Changes
01 Dec 2001	1	First Release
01 Dec 2004	2	Modifications on AMR table page 2 (explanation of Vid and Vi limits)

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